IPC - ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfg Information				
upplier Inform	ation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi											2023-06-08				
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stewa	rds		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorized Represer	ntative*		Title - Representative			F	Phone - Representative*				Email - Representative*				
Product-Env-Stewa	rds	Product Enviro Compliance			]	NA				Product-Env-Stewards@onsemi.com					
Requester	Requester Item Number Mi		Mfr Item Number Mfr Item Name			Effe		Version	N	Manufacturing Site	W	eight*	UOM	Unit Type	
		NCP304HSQ22T1G ANA UNDE		ANA UNDERVOL	OLT DETECT 2.2V		2023-06-08		N	MY1		22	mg	Each	
	Process Informatio		amainal Daga	Allow	STD-020 MSL	Dating	Dools Duos	ann Dady T	To more a martine	Mov Time at Peak	Tommorotu	no Niversh	per of Reflow Cyc	Jac	
			Terminal Base Alloy J-STD CU Alloy 1		S1D-020 MSL	Kanng	Peak Process Body Temper 260 C		T *				ber of Reflow Cyc	ries	
•	i (Sii) - anneaied	C	U Alloy	1			200		JC	30	second	s  3			
omments	me at neels termos	duning sel	domina ia 10-1	10 seconds											
	me at peak temperature														
r more informatio	on regarding material co	mposition p	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shave provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier is liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.13	mg	Supplier	Silicon (Si)	7440-21-3		0.13	mg
Die Attach	0.08		Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.0256	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0534	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.001	mg
Lead Frame	1.31		Supplier	Zinc (Zn)	7440-66-6		0.0013	mg
			Supplier	Iron (Fe)	7439-89-6		0.0301	mg
			Supplier	Copper (Cu)	7440-50-8		1.2772	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0013	mg
Mold Compound-Black	4.49			Epoxy resin	proprietary data		0.211	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.449	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0045	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.6144	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.211	mg
Plating	1.19	mg	Supplier	Tin (Sn)	7440-31-5		1.19	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5	_	0.02	mg